

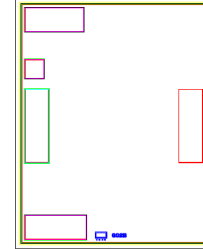
Ultra High Dynamic Range, Shutdown

# Monolithic Amplifier Die TSS-23HLN-D+

50Ω 30 MHz to 2 GHz

## The Big Deal

- Ultra-High IP3, +42.6 dBm typ.
- Medium power, +28.5 dBm typ.
- Excellent Noise Figure, 1.4 dB typ.
- Shutdown feature
- Operates over wide DC input: +3V to +8V



## Product Overview

TSS-23HLN-D+ (RoHS compliant) is an advanced wideband amplifier die with shutdown feature. It is fabricated using E-PHEMT technology and offers extremely high dynamic range over a broad frequency range and with low noise figure. In addition, the TSS-23HLN-D+ has good input and output return loss over a broad frequency range.

## Key Features

Feature	Advantages
Broad Band: 30MHz to 2GHz	Broadband covering primary wireless communications bands: VHF, UHF, Cellular
Extremely High IP3 39.6 dBm typical at 30 MHz 42.6 dBm typical at 1 GHz	The TSS-23HLN-D+ matches industry leading IP3 performance relative to device size and power consumption. The combination of the design and E-PHEMT Structure provides enhanced linearity over a broad frequency range as evidence in the IP3 being approximately 13-15 dB above the P1dB point. This feature makes this amplifier ideal for use in: <ul style="list-style-type: none"><li>• Driver amplifiers for complex waveform up converter paths</li><li>• Drivers in linearized transmit systems</li><li>• Secondary amplifiers in ultra-High Dynamic range receivers</li></ul>
Shutdown feature	Allow users to turn on and off the amplifier with pulsed signals while keeping the power supply at constant voltage to minimize DC power consumption
Low Noise Figure 1.4 dB at 1GHz	Enables lower system noise figure performance and along with High OIP3 provides high dynamic range
High P1dB, 28.5 dBm at 1 GHz	High P1dB, High OIP3, Low NF results in a very dynamic range preventing amplifier saturation under strong interfering signals.



Ultra High Dynamic Range, Shutdown

# Monolithic Amplifier Die

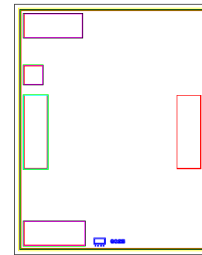
30 MHz to 2 GHz

## Product Features

- High IP3, 42.6 dBm typ. at 1 GHz
- Gain, 21.8 dB typ. at 1 GHz
- Low noise figure, 1.4 dB at 1 GHz
- High P1dB 28.5 dBm 1 GHz
- Shutdown feature
- Operates over wide DC input: +3V to 8V

## Typical Applications

- Base station infrastructure
- CATV
- Cellular



**+RoHS Compliant**

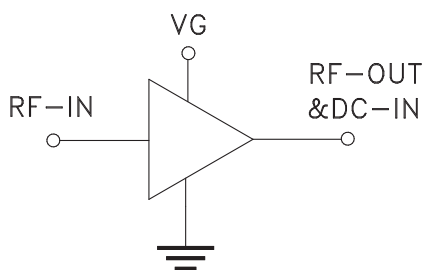
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Ordering Information: Refer to Last Page

## General Description

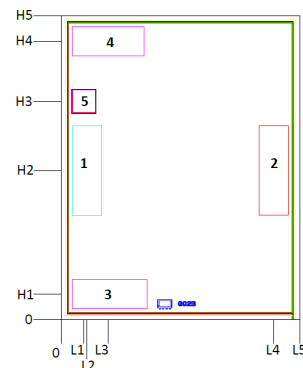
TSS-23HLN-D+ (RoHS compliant) is an advanced wideband amplifier die with shutdown feature. It is fabricated using E-PHEMT technology and offers extremely high dynamic range over a broad frequency range and with low noise figure. In addition, the TSS-23HLN-D+ has good input and output return loss over a broad frequency range.

## Simplified Schematic and Pad description



Pad#	Function
1	RF-IN
2	RF-OUT & DC-IN
5	VG
3,4	Ground

## Bonding Pad Position



Dimensions in  $\mu\text{m}$ , Typical

L1	L2	L3	L4	L5	H1	H2	H3	H4	H5	Thick-ness	Die Size	Pad Size 1	Pad Size 2	Pad Size 3	Pad Size 4	Pad Size 5
76.0	86.0	160.0	705.0	790.0	86.0	495.0	725.0	925.0	1010.0	100	1010 x 900	101 x 301	98 x 298	251 x 101	241 x 101	81 x 81

**Electrical Specifications<sup>1</sup> at 25°C, unless noted**

Parameter	Condition( MHz)	Vd = 8V		Vd = 5V		Vd = 3V		Units
		ON State	OFF State	ON State	OFF State	ON State	OFF State	
Frequency Range		30-2000	30-2000	30-2000	30-2000	30-2000	30-2000	MHz
Noise Figure	30	1.4	--	1.2	--	1.1	--	dB
	500	1.4	--	1.2	--	1.2	--	
	1000	1.4	--	1.2	--	1.2	--	
	1500	1.5	--	1.3	--	1.4	--	
	2000	1.6	--	1.4	--	1.5	--	
Gain	30	23.3	-21	23.1	-21	22.4	-21	dB
	500	22.4	-21	22.2	-21	21.4	-21	
	1000	21.8	-23	21.5	-23	20.2	-24	
	1500	21.1	-25	20.7	-26	19.1	-26	
	2000	20.3	-28	19.9	-28	18	-27	
Reversed Isolation	30-2000	27	26	27	26	27	25	dB
Input Return Loss	30	11	12	12	12	12	12	dB
	500	12	12	12	12	11	12	
	1000	10	12	10	12	8	12	
	1500	11	15	10	15	8	15	
	2000	12	20	11	19	8	19	
Output Return Loss	30	15	2	15	2	17	2	dB
	500	14	2	15	2	19	2	
	1000	12	2	16	2	18	2	
	1500	10	2	12	2	11	2	
	2000	8	2	10	2	9	2	
Output Power @ 1dB compression AMP-ON	30	26.2	--	22.8	--	17.1	--	dBm
	500	27.9	--	23.8	--	18.9	--	
	1000	28.5	--	24.1	--	19	--	
	1500	28.1	--	23.5	--	18.8	--	
	2000	27.7	--	22.8	--	18.1	--	
Output IP3 (Pout = 0dBm/Tone)	30	39.6	--	39.8	--	34.1	--	dBm
	500	41.6	--	38	--	33.7	--	
	1000	42.6	--	36.4	--	31.8	--	
	1500	42.6	--	35.5	--	31.1	--	
	2000	41.8	--	34	--	30.3	--	
Device Operating Voltage(VDD)		8	8	5	5	3	3	V
Device Operating Current(ID)		236	8	139	5	74	3	mA
Control Voltage (VG)		0	5	0	5	0	5	V
Device Current Variation vs. Temperature		-225 <sup>2</sup>	--	-13 <sup>3</sup>	--	27 <sup>3</sup>	--	uA/degC
Device Current Variation vs. Voltage		0.0263	--	0.034	--	0.033	--	mA/mV
Thermal Resistance		23.3	--	23.3	--	23.3	--	degC/W

1. Measured on Mini-Circuits Characterization test board. Die is packaged in 3x3 mm, 12-lead MCL package and soldered on TB-TSS-23HLN+. See Characterization Test Circuit (Fig. 1)

2. (Current at 95°C - Current at -45°C)/140

3. (Current at 105°C - Current at -45°C)/150

**Absolute Maximum Ratings<sup>4</sup>**

Parameter	at 8V	at 3V&5V
Operating Temperature (ground lead)	-40°C to 95°C	-40°C to 105°C
Power Dissipation	3.3W	3.3W
Device Operating Current (ID)	249mA	163mA
Input Power (CW)	+28 dBm (5 minutes max) +15 dBm (continuous) for 0.03-1 GHz +18 dBm (continuous) for 1-2 GHz	+28 dBm (5 minutes max) +10 dBm (continuous) for 0.03-1 GHz +13 dBm (continuous) for 1-2 GHz
DC Voltage on Pad 2	10V	10V
DC Voltage on Pad 5	10V	10V

4. Permanent damage may occur if any of these limits are exceeded.  
Electrical maximum ratings are not intended for continuous normal operation.

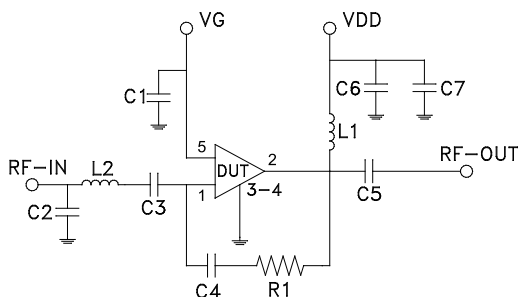
Switching Specifications

Parameter		8V Typ	5V Typ.	3V Typ.	Units
Amplifier ON to Shutdown	OFF TIME (50% Control to 10% RF)	5.3	4.8	6.2	µs
	FALL TIME (90 to 10% RF)	7.3	7.4	3.6	
Amplifier Shutdown to ON	ON TIME (50% Control to 90% RF)	77.7	95.2	144.7	µs
	RISE TIME (10% to 90% RF)	54.2	60.0	200.7	
Control Voltage Leakage		633.3	482.9	311.0	mV

Control Voltage (V<sub>G</sub>) Fig. 1

	Min.	Typ.	Max.	Units
Amplifier-ON	—	0	0.7	V
Amplifier-OFF	1.9	5	—	V

Characterization Test Circuit / Recommended Application Circuit



Component	Size	Value	Part Number	Manufacturer
C1	0402	0.1µF	GRM155R71C104KA88D	Murata
C2	0402	1.2pF	GRM1555C1H1R2CA1D	Murata
C3	0402	0.1µF	GRM155R71C104KA88D	Murata
C4	0402	0.1µF	GRM155R71C104KA88D	Murata
C5	0402	1000pF	GRM1555C1H102JA01D	Murata
C6	0402	10000pF	GRM155R71E103KA01D	Murata
C7	0402	0.1µF	GRM155R71C104KA88D	Murata
L1	0805	680nH	0805LS-681XJLB	Coilcraft
L2	0402	1.0nH	0402CS-1N0XJLW	Coilcraft
R1	0402	1.2KOhm	RK73H1ETTP1201F	Koa

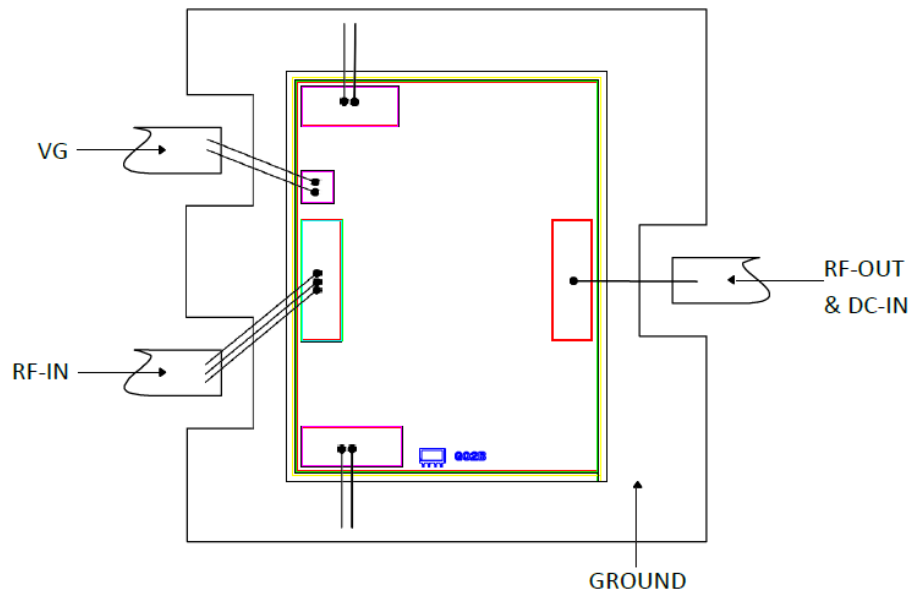
Fig 1. Block diagram of Test Circuit used for characterization. (DUT is packaged 3x3mm, 12-lead MCLP package and soldered on Mini-Circuits Characterization test board TB-TSS-23HLN+)

Gain, Return loss, Output power at 1dB compression (P1dB) , output IP3 (OIP3) and noise figure measured using Agilent’s N5242A PNA-X microwave network analyzer.

Conditions:

- Gain and Return Loss: Pin= -25dBm
- Output IP3 (OIP3): Two tones, spaced 1 MHz apart, +0dBm/tone at output.
- Switching Time  
 RF Signal: Pin=-25 dBm, f<sub>RF</sub>=500 MHz.  
 V<sub>DD</sub>=8V,5V or 3V DC, V<sub>G</sub>=Pulse signal at 1 KHz with V<sub>HIGH</sub>=5V, V<sub>LOW</sub>=0V, 50% duty cycle.

## Assembly Diagram



## Assembly and Handling Procedure

1. Storage  
Dice should be stored in a dry nitrogen purged desiccators or equivalent.
2. ESD  
MMIC E-PHEMT amplifier dice are susceptible to electrostatic and mechanical damage. Die are supplied in antistatic protected material, which should be opened in clean room conditions at an appropriately grounded anti-static workstation. Devices need careful handling using correctly designed collets, vacuum pickup tips or sharp antistatic tweezers to deter ESD damage to dice.
3. Die Attach  
The die mounting surface must be clean and flat. Using conductive silver filled epoxy, recommended epoxies are DieMat DM6030HK-PT/H579 or Ablestik 84-1LMISR4. Apply sufficient epoxy to meet required epoxy bond line thickness, epoxy fillet height and epoxy coverage around total die periphery. Parts shall be cured in a nitrogen filled atmosphere per manufacturer's cure condition. It is recommended to use antistatic die pick up tools only.
4. Wire Bonding  
Bond pad openings in the surface passivation above the bond pads are provided to allow wire bonding to the dice gold bond pads. Thermosonic bonding is used with minimized ultrasonic content. Bond force, time, ultrasonic power and temperature are all critical parameters. Suggested wire is pure gold, 1 mil diameter. Bonds must be made from the bond pads on the die to the package or substrate. All bond wires should be kept as short as low as reasonable to minimize performance degradation due to undesirable series inductance.

<b>Additional Detailed Technical Information</b> <i>additional information is available on our dash board.</i>	
<b>Performance Data</b>	Data Table
	Swept Graphs
	S-Parameter (S2P Files) Data Set with and without port extension(.zip file)
<b>Case Style</b>	Die
<b>Die Ordering and packaging information</b>	Quantity, Package <span style="float: right;">Model No.</span>
	Small, Gel - Pak: 5,10,50,100 KGD* <span style="float: right;">TSS-23HLN-DG+</span> Medium <sup>†</sup> , Partial wafer: KGD*<1672 <span style="float: right;">TSS-23HLN-DP+</span> Large <sup>†</sup> , Full Wafer <span style="float: right;">TSS-23HLN-DF+</span>
	<sup>†</sup> Available upon request contact sales representative
	Refer to <a href="#">AN-60-067</a>
<b>Environmental Ratings</b>	ENV80

\*Known Good Dice ("KGD") means that the dice in question have been subjected to Mini-Circuits DC test performance criteria and measurement instructions and that the parametric data of such dice fall within a predefined range. While DC testing is not definitive, it does help to provide a higher degree of confidence that dice are capable of meeting typical RF electrical parameters specified by Mini-Circuits.

**ESD Rating\*\***

Human Body Model (HBM): Class 1A (pass 250V) in accordance with ANSI/ESD STM 5.1 - 2001

\*\* Tested in industry standard 3X3 mm, 12 lead MCLP package.

**Additional Notes**

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## Typical Performance Data

### Definitions:

Input Return Loss = -S11 (dB)

Gain(Power Gain) = S21 (dB)

Reverse Isolation = -S12 (dB)

Output Return Loss = -S22 (dB)

TEST CONDITIONS: Vd = 2.75V, Id = 64mA @ Temperature = +25°C

FREQ	Gain	Isolation	Input Return Loss	Output Return Loss	Stability		IP-3 Output	1dB Comp. Output	Noise Figure
					K	Measure			
(MHz)	(dB)	(dB)	(dB)	(dB)	K	Measure	(dBm)	(dBm)	(dB)
20	22.55	25.80	10.51	15.85	1.03	0.53	30.81	14.56	1.13
30	22.27	25.29	12.15	16.81	1.03	0.50	33.06	15.77	1.07
40	22.07	25.00	13.12	16.48	1.03	0.48	32.74	16.96	1.04
50	21.92	25.08	14.05	15.81	1.04	0.50	32.52	17.66	1.09
60	21.86	24.80	14.18	15.84	1.04	0.47	32.93	17.76	1.08
70	21.81	24.75	14.40	15.66	1.04	0.47	33.12	17.98	1.09
80	21.77	24.66	14.56	15.63	1.04	0.46	33.16	17.97	1.13
90	21.74	24.76	14.68	15.57	1.04	0.47	33.59	18.03	1.16
100	21.71	24.68	14.74	15.54	1.04	0.46	33.89	18.02	1.15
150	21.64	24.73	14.61	15.65	1.05	0.48	33.29	18.18	1.22
200	21.58	24.76	14.20	15.93	1.05	0.50	34.22	18.24	1.17
250	21.53	24.78	13.65	16.37	1.05	0.51	33.83	18.33	1.16
300	21.47	24.84	13.05	16.85	1.05	0.53	33.09	18.46	1.16
350	21.40	24.90	12.39	17.53	1.05	0.56	32.82	18.44	1.19
400	21.32	25.04	11.77	18.29	1.06	0.59	32.84	18.36	1.21
450	21.23	25.16	11.17	19.18	1.06	0.62	32.38	18.19	1.18
500	21.13	25.29	10.57	20.16	1.07	0.66	32.51	17.98	1.20
550	21.02	25.45	10.05	21.11	1.07	0.70	31.91	18.26	1.20
600	20.90	25.54	9.57	21.97	1.07	0.73	31.67	18.09	1.26
650	20.78	25.66	9.13	22.43	1.08	0.76	31.19	18.17	1.27
700	20.65	25.82	8.78	22.44	1.08	0.79	31.21	18.06	1.25
750	20.50	25.93	8.44	22.00	1.09	0.82	31.08	17.93	1.24
800	20.36	26.01	8.17	21.12	1.09	0.85	30.91	17.88	1.32
850	20.22	26.18	7.94	20.09	1.10	0.87	30.65	18.02	1.27
900	20.09	26.30	7.72	19.00	1.10	0.90	30.36	17.94	1.27
950	19.97	26.41	7.52	17.98	1.10	0.92	30.62	17.89	1.27
1000	19.84	26.48	7.39	17.01	1.11	0.93	30.35	18.08	1.26
1100	19.59	26.66	7.18	15.28	1.11	0.96	30.13	17.89	1.31
1200	19.35	26.80	7.10	13.84	1.12	0.97	30.04	17.89	1.36
1300	19.12	26.93	7.13	12.70	1.12	0.98	30.00	17.66	1.36
1400	18.92	27.01	7.24	11.71	1.13	0.98	29.87	17.67	1.37
1500	18.73	27.07	7.43	10.88	1.13	0.97	29.76	17.80	1.38
1600	18.54	27.11	7.68	10.18	1.13	0.96	29.41	17.58	1.39
1700	18.36	27.17	7.96	9.63	1.14	0.96	29.28	17.18	1.42
1800	18.15	27.21	8.19	9.20	1.14	0.95	29.49	17.42	1.42
1900	17.90	27.27	8.28	8.86	1.15	0.96	29.08	17.32	1.44
2000	17.60	27.37	8.13	8.62	1.16	0.97	28.98	17.12	1.50
2100	17.22	27.51	7.69	8.47	1.17	1.00	28.57	17.00	1.57
2200	16.77	27.80	6.99	8.38	1.19	1.04	28.54	16.80	1.71
2300	16.22	28.15	6.18	8.32	1.22	1.09	28.14	16.76	1.86
2400	15.57	28.46	5.35	8.31	1.24	1.14	27.77	16.54	2.03
2500	14.86	28.93	4.57	8.31	1.28	1.20	27.84	16.53	3.00

Note: Test data of Die packaged in industry standard 3x3 mm, 12-lead MCL package



## Typical Performance Data

### Definitions:

Input Return Loss = -S11 (dB)

Gain(Power Gain) = S21 (dB)

Reverse Isolation = -S12 (dB)

Output Return Loss = -S22 (dB)

TEST CONDITIONS: Vd = 3.00V, Id = 73mA @ Temperature = +25°C

FREQ	Gain	Isolation	Input Return Loss	Output Return Loss	Stability		IP-3 Output	1dB Comp. Output	Noise Figure
					K	Measure			
(MHz)	(dB)	(dB)	(dB)	(dB)			(dBm)	(dBm)	(dB)
20	22.74	25.90	10.52	15.57	1.03	0.52	32.76	15.76	1.16
30	22.45	25.37	12.04	16.35	1.03	0.49	34.88	16.98	1.13
40	22.24	25.17	12.91	15.92	1.03	0.48	33.86	18.16	1.08
50	22.09	25.43	13.62	15.26	1.05	0.51	34.02	18.75	1.08
60	22.03	25.00	13.85	15.29	1.04	0.47	34.94	18.84	1.09
70	21.97	24.92	14.08	15.11	1.04	0.46	34.98	18.95	1.11
80	21.93	24.80	14.20	15.08	1.04	0.45	34.69	18.91	1.13
90	21.91	24.87	14.30	15.00	1.04	0.46	34.66	18.98	1.18
100	21.88	24.84	14.35	15.00	1.04	0.46	35.65	19.04	1.17
150	21.81	24.84	14.27	15.08	1.04	0.47	34.88	19.11	1.12
200	21.75	24.91	13.98	15.32	1.05	0.49	36.52	19.25	1.17
250	21.70	24.86	13.49	15.72	1.05	0.49	35.19	19.34	1.17
300	21.65	24.96	13.03	16.13	1.05	0.52	34.53	19.40	1.16
350	21.59	25.02	12.47	16.71	1.05	0.54	34.69	19.38	1.17
400	21.52	25.18	11.94	17.36	1.06	0.58	34.35	19.29	1.18
450	21.44	25.23	11.39	18.10	1.06	0.60	33.97	19.14	1.19
500	21.35	25.41	10.83	18.97	1.06	0.64	33.79	18.92	1.21
550	21.25	25.51	10.36	19.81	1.07	0.67	33.11	19.23	1.21
600	21.15	25.62	9.88	20.69	1.07	0.70	32.96	19.04	1.26
650	21.03	25.71	9.46	21.40	1.07	0.73	32.91	19.04	1.27
700	20.91	25.85	9.11	21.87	1.08	0.76	32.61	18.94	1.24
750	20.78	25.97	8.78	21.93	1.09	0.79	32.36	18.89	1.23
800	20.64	26.11	8.50	21.55	1.09	0.82	32.23	18.77	1.19
850	20.52	26.27	8.26	20.89	1.10	0.85	32.18	19.01	1.25
900	20.39	26.35	8.03	20.02	1.10	0.87	31.73	18.94	1.23
950	20.28	26.53	7.83	19.05	1.11	0.89	31.91	18.80	1.25
1000	20.15	26.57	7.68	18.06	1.11	0.91	31.67	19.02	1.25
1100	19.91	26.76	7.46	16.26	1.12	0.94	31.41	18.92	1.31
1200	19.67	26.92	7.36	14.71	1.13	0.95	31.52	18.93	1.32
1300	19.45	27.07	7.39	13.43	1.14	0.96	31.27	18.71	1.33
1400	19.25	27.16	7.49	12.32	1.14	0.96	31.15	18.64	1.34
1500	19.07	27.24	7.69	11.41	1.15	0.96	31.08	18.80	1.37
1600	18.90	27.34	7.98	10.62	1.16	0.95	30.82	18.59	1.40
1700	18.73	27.32	8.33	9.99	1.16	0.94	30.49	18.09	1.42
1800	18.54	27.35	8.66	9.49	1.16	0.93	30.88	18.49	1.40
1900	18.33	27.42	8.87	9.08	1.16	0.94	30.42	18.42	1.46
2000	18.06	27.56	8.83	8.79	1.18	0.95	30.48	18.13	1.48
2100	17.73	27.66	8.46	8.60	1.19	0.97	29.90	18.14	1.56
2200	17.31	27.89	7.72	8.51	1.20	1.01	29.88	17.86	1.71
2300	16.78	28.22	6.80	8.47	1.23	1.06	29.49	17.83	1.86
2400	16.15	28.66	5.85	8.47	1.27	1.12	29.16	17.53	2.08
2500	15.43	29.10	4.97	8.51	1.31	1.18	29.36	17.68	2.36

Note: Test data of Die packaged in industry standard 3x3 mm, 12-lead MCL package





## Typical Performance Data

### Definitions:

Input Return Loss = -S11 (dB)

Gain(Power Gain) = S21 (dB)

Reverse Isolation = -S12 (dB)

Output Return Loss = -S22 (dB)

TEST CONDITIONS: Vd = 3.25V, Id = 81mA @ Temperature = +25°C

FREQ	Gain	Isolation	Input Return Loss	Output Return Loss	Stability		IP-3 Output	1dB Comp. Output	Noise Figure
					K	Measure			
(MHz)	(dB)	(dB)	(dB)	(dB)			(dBm)	(dBm)	(dB)
20	22.87	25.93	10.51	15.50	1.02	0.51	33.20	16.78	1.11
30	22.57	25.45	11.98	15.94	1.02	0.48	35.23	18.08	1.06
40	22.37	25.23	12.79	15.47	1.03	0.47	34.63	19.16	1.02
50	22.21	25.81	13.40	14.83	1.06	0.53	34.99	19.72	1.07
60	22.15	25.11	13.67	14.86	1.04	0.46	36.53	19.79	1.07
70	22.09	25.00	13.88	14.70	1.04	0.45	35.67	19.82	1.10
80	22.05	24.92	13.99	14.66	1.03	0.44	35.38	19.76	1.10
90	22.02	24.98	14.08	14.57	1.04	0.45	36.43	19.83	1.13
100	22.00	24.90	14.13	14.57	1.04	0.45	35.11	19.89	1.14
150	21.93	24.98	14.10	14.61	1.04	0.46	36.98	19.95	1.21
200	21.87	25.00	13.87	14.86	1.05	0.48	35.92	20.02	1.16
250	21.83	25.00	13.47	15.24	1.05	0.49	35.49	20.13	1.17
300	21.78	25.09	13.09	15.63	1.05	0.51	36.50	20.26	1.16
350	21.72	25.17	12.59	16.18	1.05	0.54	35.92	20.24	1.17
400	21.66	25.26	12.12	16.81	1.06	0.56	35.57	20.16	1.19
450	21.59	25.36	11.62	17.56	1.06	0.59	34.76	20.01	1.17
500	21.50	25.45	11.10	18.39	1.06	0.62	35.31	19.71	1.19
550	21.41	25.56	10.64	19.24	1.07	0.65	34.01	20.12	1.19
600	21.31	25.69	10.19	20.10	1.07	0.68	33.75	19.92	1.24
650	21.21	25.82	9.80	20.87	1.08	0.72	33.91	19.94	1.25
700	21.10	25.95	9.45	21.39	1.08	0.75	33.53	19.83	1.23
750	20.97	26.06	9.12	21.62	1.09	0.77	33.03	19.71	1.23
800	20.85	26.21	8.86	21.38	1.10	0.80	33.23	19.59	1.28
850	20.73	26.26	8.63	20.86	1.10	0.82	32.76	19.85	1.24
900	20.62	26.42	8.41	20.06	1.11	0.85	32.51	19.78	1.25
950	20.51	26.52	8.22	19.13	1.11	0.87	32.92	19.64	1.21
1000	20.40	26.62	8.07	18.19	1.11	0.88	32.66	19.88	1.24
1100	20.17	26.79	7.86	16.40	1.12	0.91	32.44	19.79	1.30
1200	19.96	26.95	7.77	14.84	1.13	0.93	32.16	19.81	1.33
1300	19.76	27.06	7.82	13.59	1.14	0.93	32.20	19.60	1.35
1400	19.57	27.17	7.94	12.50	1.14	0.93	32.24	19.53	1.34
1500	19.40	27.26	8.15	11.59	1.15	0.93	31.97	19.70	1.33
1600	19.23	27.34	8.44	10.84	1.15	0.93	31.45	19.41	1.39
1700	19.07	27.40	8.76	10.23	1.16	0.92	31.29	18.97	1.37
1800	18.88	27.45	9.05	9.77	1.16	0.92	31.53	19.40	1.37
1900	18.66	27.55	9.18	9.39	1.17	0.93	30.94	19.24	1.40
2000	18.38	27.69	9.03	9.12	1.18	0.94	31.06	19.03	1.47
2100	18.05	27.85	8.55	8.95	1.20	0.97	30.66	18.96	1.52
2200	17.64	28.07	7.76	8.84	1.21	1.01	30.59	18.75	1.63
2300	17.13	28.33	6.83	8.79	1.22	1.06	30.19	18.66	1.78
2400	16.53	28.73	5.88	8.77	1.25	1.12	29.86	18.36	1.95
2500	15.86	29.14	5.00	8.76	1.27	1.18	29.89	18.47	2.24

Note: Test data of Die packaged in industry standard 3x3 mm, 12-lead MCL package



## Typical Performance Data

### Definitions:

Input Return Loss = -S11 (dB)

Gain(Power Gain) = S21 (dB)

Reverse Isolation = -S12 (dB)

Output Return Loss = -S22 (dB)

TEST CONDITIONS: Vd = 4.75V, Id = 134mA @ Temperature = +25°C

FREQ	Gain	Isolation	Input Return Loss	Output Return Loss	Stability		IP-3 Output	1dB Comp. Output	Noise Figure
					K	Measure			
(MHz)	(dB)	(dB)	(dB)	(dB)			(dBm)	(dBm)	(dB)
20	23.37	26.36	10.44	14.76	1.02	0.49	36.40	21.36	1.17
30	23.04	25.86	11.65	14.81	1.02	0.46	39.34	22.32	1.09
40	22.82	25.61	12.23	14.31	1.02	0.44	39.72	23.00	1.04
50	22.66	25.97	12.77	13.69	1.04	0.49	36.78	23.36	1.09
60	22.60	25.46	12.83	13.68	1.03	0.43	38.54	23.32	1.11
70	22.54	25.38	12.97	13.54	1.03	0.42	41.60	23.32	1.10
80	22.49	25.36	13.02	13.48	1.03	0.42	38.21	23.24	1.15
90	22.47	25.40	13.12	13.41	1.04	0.43	40.48	23.38	1.14
100	22.44	25.36	13.17	13.39	1.04	0.43	38.87	23.36	1.15
150	22.37	25.36	13.21	13.38	1.04	0.43	39.42	23.44	1.24
200	22.33	25.36	13.19	13.51	1.04	0.44	42.51	23.59	1.18
250	22.30	25.36	13.06	13.73	1.04	0.45	39.89	23.73	1.18
300	22.27	25.45	12.93	13.96	1.05	0.47	37.61	23.81	1.16
350	22.23	25.47	12.73	14.25	1.05	0.48	39.37	23.81	1.20
400	22.19	25.58	12.51	14.59	1.05	0.50	37.85	23.71	1.19
450	22.15	25.65	12.25	14.97	1.06	0.52	38.47	23.52	1.18
500	22.09	25.72	11.91	15.39	1.06	0.55	37.80	23.31	1.19
550	22.04	25.85	11.62	15.77	1.07	0.57	38.31	23.76	1.20
600	21.97	25.94	11.30	16.17	1.07	0.59	37.76	23.47	1.25
650	21.90	26.04	10.99	16.49	1.08	0.62	36.69	23.53	1.25
700	21.83	26.14	10.72	16.76	1.08	0.64	36.68	23.43	1.23
750	21.74	26.22	10.45	16.97	1.09	0.66	36.40	23.23	1.21
800	21.65	26.42	10.23	17.04	1.10	0.69	35.79	23.23	1.23
850	21.57	26.50	10.04	17.10	1.10	0.71	36.35	23.44	1.22
900	21.49	26.62	9.83	16.98	1.11	0.73	35.67	23.27	1.24
950	21.41	26.69	9.64	16.73	1.11	0.74	35.09	23.16	1.25
1000	21.33	26.84	9.50	16.39	1.12	0.76	36.12	23.55	1.20
1100	21.16	27.02	9.30	15.52	1.14	0.79	35.59	23.35	1.27
1200	21.00	27.26	9.24	14.55	1.15	0.81	35.31	23.40	1.30
1300	20.84	27.47	9.30	13.62	1.17	0.82	34.86	23.01	1.32
1400	20.70	27.69	9.47	12.77	1.19	0.83	34.81	22.95	1.33
1500	20.57	27.82	9.75	11.97	1.20	0.83	34.64	23.15	1.31
1600	20.44	27.99	10.13	11.33	1.21	0.83	34.11	22.77	1.34
1700	20.31	28.18	10.60	10.79	1.23	0.84	33.13	22.07	1.33
1800	20.17	28.35	11.05	10.36	1.25	0.84	34.08	22.88	1.36
1900	20.00	28.55	11.36	10.01	1.27	0.85	33.55	22.74	1.38
2000	19.80	28.69	11.26	9.75	1.27	0.87	33.32	22.42	1.42
2100	19.54	28.92	10.68	9.56	1.29	0.90	33.93	22.45	1.48
2200	19.22	29.28	9.65	9.42	1.31	0.95	32.50	22.07	1.59
2300	18.81	29.70	8.43	9.33	1.34	1.00	32.51	22.11	1.73
2400	18.32	30.14	7.19	9.23	1.37	1.06	32.16	21.68	1.89
2500	17.75	30.53	6.05	9.15	1.38	1.12	32.50	21.90	2.16

Note: Test data of Die packaged in industry standard 3x3 mm, 12-lead MCL package



## Typical Performance Data

### Definitions:

Input Return Loss = -S11 (dB)

Gain(Power Gain) = S21 (dB)

Reverse Isolation = -S12 (dB)

Output Return Loss = -S22 (dB)

TEST CONDITIONS: Vd = 5.00V, Id = 143mA @ Temperature = +25°C

FREQ	Gain	Isolation	Input Return Loss	Output Return Loss	Stability		IP-3 Output	1dB Comp. Output	Noise Figure
					K	Measure			
(MHz)	(dB)	(dB)	(dB)	(dB)			(dBm)	(dBm)	(dB)
20	23.44	26.51	10.42	14.74	1.02	0.50	38.03	21.98	1.20
30	23.11	25.94	11.59	14.76	1.02	0.46	38.75	22.79	1.16
40	22.88	25.69	12.12	14.23	1.02	0.44	39.63	23.39	1.10
50	22.72	25.49	12.71	13.77	1.03	0.42	39.07	23.80	1.09
60	22.65	25.47	12.70	13.63	1.03	0.43	39.61	23.70	1.11
70	22.59	25.40	12.83	13.47	1.03	0.42	42.10	23.76	1.11
80	22.55	25.47	12.89	13.42	1.03	0.43	40.26	23.69	1.14
90	22.52	25.31	12.99	13.37	1.03	0.41	42.01	23.76	1.17
100	22.50	25.38	13.02	13.33	1.03	0.42	37.95	23.80	1.19
150	22.43	25.35	13.07	13.32	1.04	0.42	41.98	23.82	1.16
200	22.38	25.39	13.03	13.43	1.04	0.44	40.57	23.97	1.18
250	22.35	25.46	12.94	13.59	1.04	0.45	37.96	24.11	1.16
300	22.33	25.47	12.82	13.79	1.05	0.46	38.94	24.25	1.16
350	22.29	25.57	12.64	14.03	1.05	0.48	36.74	24.19	1.18
400	22.25	25.60	12.45	14.30	1.05	0.49	36.45	24.17	1.21
450	22.22	25.67	12.21	14.59	1.06	0.51	37.28	23.98	1.19
500	22.16	25.75	11.91	14.93	1.06	0.53	38.33	23.78	1.19
550	22.11	25.87	11.67	15.22	1.07	0.56	38.08	24.14	1.20
600	22.05	25.94	11.35	15.53	1.07	0.58	37.21	23.93	1.28
650	21.98	26.06	11.06	15.77	1.08	0.60	37.95	24.00	1.28
700	21.91	26.17	10.82	15.98	1.08	0.62	37.12	23.81	1.23
750	21.83	26.34	10.56	16.14	1.09	0.65	36.45	23.70	1.23
800	21.74	26.40	10.34	16.22	1.10	0.67	36.52	23.62	1.20
850	21.67	26.50	10.16	16.29	1.10	0.69	36.32	23.83	1.22
900	21.59	26.59	9.94	16.22	1.11	0.71	36.16	23.76	1.23
950	21.52	26.73	9.77	16.07	1.12	0.73	35.94	23.66	1.23
1000	21.44	26.83	9.63	15.81	1.12	0.74	36.80	24.05	1.22
1100	21.27	27.07	9.41	15.11	1.14	0.77	36.25	23.74	1.26
1200	21.11	27.34	9.32	14.29	1.16	0.80	35.24	23.79	1.32
1300	20.95	27.58	9.38	13.46	1.18	0.81	35.24	23.51	1.32
1400	20.81	27.76	9.53	12.66	1.20	0.82	35.32	23.45	1.30
1500	20.68	27.94	9.81	11.90	1.21	0.82	35.24	23.53	1.35
1600	20.55	28.15	10.22	11.26	1.23	0.82	34.29	23.27	1.34
1700	20.43	28.27	10.76	10.72	1.24	0.82	33.98	22.46	1.34
1800	20.30	28.48	11.34	10.28	1.26	0.83	34.57	23.39	1.34
1900	20.15	28.64	11.80	9.91	1.28	0.83	34.35	23.26	1.42
2000	19.97	28.98	11.92	9.63	1.31	0.85	33.93	22.85	1.44
2100	19.74	29.21	11.47	9.42	1.33	0.88	34.05	22.90	1.51
2200	19.44	29.52	10.42	9.29	1.35	0.92	33.06	22.43	1.65
2300	19.05	29.90	9.07	9.19	1.37	0.97	33.40	22.47	1.78
2400	18.56	30.34	7.70	9.12	1.40	1.03	32.57	22.04	1.96
2500	17.99	30.83	6.45	9.03	1.43	1.10	32.95	22.25	2.24

Note: Test data of Die packaged in industry standard 3x3 mm, 12-lead MCL package



## Typical Performance Data

### Definitions:

Input Return Loss = -S11 (dB)

Gain(Power Gain) = S21 (dB)

Reverse Isolation = -S12 (dB)

Output Return Loss = -S22 (dB)

TEST CONDITIONS: Vd = 5.25V, Id = 151mA @ Temperature = +25°C

FREQ	Gain	Isolation	Input Return Loss	Output Return Loss	Stability		IP-3 Output	1dB Comp. Output	Noise Figure
					K	Measure			
(MHz)	(dB)	(dB)	(dB)	(dB)			(dBm)	(dBm)	(dB)
20	23.47	26.51	10.43	14.70	1.02	0.49	35.45	22.49	1.22
30	23.14	25.93	11.56	14.74	1.02	0.45	40.19	23.18	1.14
40	22.91	25.70	12.11	14.19	1.02	0.44	38.43	23.84	1.10
50	22.75	25.25	12.57	13.72	1.02	0.39	40.22	24.20	1.14
60	22.68	25.51	12.66	13.55	1.03	0.43	38.35	24.16	1.14
70	22.62	25.46	12.79	13.41	1.03	0.42	44.88	24.15	1.11
80	22.58	25.52	12.85	13.35	1.04	0.43	39.98	24.08	1.15
90	22.55	25.36	12.94	13.31	1.03	0.41	39.60	24.22	1.17
100	22.52	25.37	12.98	13.26	1.03	0.42	37.44	24.20	1.20
150	22.46	25.42	13.06	13.24	1.04	0.43	42.74	24.28	1.24
200	22.41	25.44	13.04	13.33	1.04	0.44	39.31	24.44	1.18
250	22.39	25.52	12.97	13.50	1.04	0.45	37.42	24.58	1.19
300	22.36	25.48	12.87	13.68	1.04	0.46	41.52	24.66	1.20
350	22.32	25.61	12.69	13.92	1.05	0.48	38.79	24.67	1.21
400	22.29	25.65	12.52	14.17	1.05	0.49	38.50	24.66	1.22
450	22.25	25.69	12.32	14.48	1.06	0.51	39.29	24.47	1.22
500	22.20	25.81	12.02	14.80	1.06	0.53	38.38	24.20	1.21
550	22.15	25.92	11.77	15.07	1.07	0.56	38.41	24.64	1.22
600	22.09	25.98	11.49	15.35	1.07	0.57	38.87	24.44	1.29
650	22.02	26.06	11.20	15.57	1.07	0.59	37.71	24.43	1.28
700	21.96	26.19	10.96	15.70	1.08	0.62	38.09	24.33	1.26
750	21.87	26.29	10.70	15.82	1.09	0.64	37.14	24.13	1.24
800	21.79	26.46	10.50	15.85	1.10	0.66	36.78	24.15	1.28
850	21.72	26.52	10.32	15.84	1.10	0.68	37.58	24.36	1.28
900	21.64	26.64	10.13	15.73	1.11	0.70	36.57	24.29	1.24
950	21.57	26.73	9.94	15.54	1.11	0.71	36.09	24.20	1.25
1000	21.50	26.85	9.82	15.26	1.12	0.73	36.88	24.59	1.26
1100	21.34	27.11	9.62	14.56	1.14	0.76	36.16	24.29	1.29
1200	21.19	27.34	9.56	13.77	1.16	0.78	36.24	24.35	1.35
1300	21.04	27.55	9.64	13.00	1.17	0.79	35.78	23.97	1.34
1400	20.90	27.78	9.83	12.26	1.19	0.80	35.37	23.91	1.35
1500	20.78	28.02	10.13	11.58	1.21	0.81	36.00	24.10	1.36
1600	20.65	28.17	10.53	11.01	1.23	0.81	35.15	23.73	1.37
1700	20.54	28.43	11.05	10.54	1.25	0.81	34.28	22.91	1.37
1800	20.40	28.59	11.56	10.16	1.27	0.82	35.20	23.85	1.37
1900	20.25	28.93	11.90	9.82	1.30	0.84	35.11	23.72	1.38
2000	20.05	29.16	11.83	9.58	1.32	0.86	34.23	23.39	1.44
2100	19.81	29.46	11.21	9.39	1.34	0.89	34.68	23.43	1.50
2200	19.51	29.82	10.12	9.23	1.37	0.93	33.76	22.85	1.61
2300	19.12	30.24	8.81	9.10	1.39	0.98	33.42	22.89	1.76
2400	18.65	30.64	7.50	8.98	1.41	1.04	32.60	22.47	1.94
2500	18.11	31.18	6.32	8.84	1.44	1.10	33.09	22.82	3.16

Note: Test data of Die packaged in industry standard 3x3 mm, 12-lead MCL package



## Typical Performance Data

### Definitions:

Input Return Loss = -S11 (dB)

Gain(Power Gain) = S21 (dB)

Reverse Isolation = -S12 (dB)

Output Return Loss = -S22 (dB)

TEST CONDITIONS: Vd = 7.60V, Id = 224mA @ Temperature = +25°C

FREQ	Gain	Isolation	Input Return Loss	Output Return Loss	Stability		IP-3 Output	1dB Comp. Output	Noise Figure
					K	Measure			
(MHz)	(dB)	(dB)	(dB)	(dB)			(dBm)	(dBm)	(dB)
20	23.64	26.42	10.43	14.93	1.02	0.46	37.10	25.81	1.43
30	23.29	26.11	11.40	14.80	1.02	0.46	37.46	25.89	1.34
40	23.06	25.81	11.84	14.20	1.02	0.43	42.33	27.04	1.29
50	22.88	26.31	12.33	13.56	1.05	0.50	38.72	27.41	1.33
60	22.82	25.68	12.28	13.54	1.03	0.43	42.21	27.07	1.30
70	22.76	25.60	12.37	13.37	1.03	0.42	41.75	26.92	1.30
80	22.71	25.55	12.41	13.31	1.03	0.42	39.46	27.17	1.34
90	22.68	25.60	12.48	13.23	1.04	0.43	43.53	27.22	1.36
100	22.66	25.54	12.51	13.20	1.03	0.42	37.86	27.20	1.34
150	22.59	25.59	12.56	13.09	1.04	0.43	42.24	27.31	1.42
200	22.55	25.61	12.57	13.12	1.04	0.44	42.46	27.45	1.37
250	22.52	25.58	12.54	13.19	1.04	0.44	38.55	27.57	1.34
300	22.49	25.64	12.51	13.21	1.05	0.45	41.92	27.73	1.32
350	22.46	25.68	12.41	13.30	1.05	0.46	41.61	27.71	1.35
400	22.43	25.84	12.30	13.36	1.05	0.48	41.84	27.72	1.38
450	22.40	25.86	12.16	13.43	1.06	0.49	43.02	27.61	1.34
500	22.35	25.91	11.95	13.52	1.06	0.51	42.72	27.47	1.37
550	22.30	26.04	11.76	13.52	1.07	0.53	44.56	27.81	1.39
600	22.25	26.16	11.55	13.55	1.07	0.55	47.18	27.72	1.43
650	22.19	26.23	11.34	13.49	1.08	0.56	41.99	27.76	1.43
700	22.13	26.38	11.14	13.40	1.08	0.58	43.66	27.68	1.40
750	22.06	26.47	10.93	13.31	1.09	0.60	42.19	27.59	1.40
800	21.99	26.63	10.78	13.16	1.10	0.62	42.07	27.56	1.41
850	21.92	26.74	10.63	13.04	1.11	0.63	42.16	27.83	1.41
900	21.86	26.83	10.46	12.86	1.11	0.64	40.39	27.72	1.40
950	21.79	26.98	10.31	12.66	1.12	0.66	42.83	27.75	1.41
1000	21.73	27.11	10.20	12.41	1.13	0.67	42.72	28.04	1.37
1100	21.58	27.37	10.04	11.90	1.15	0.69	41.55	27.85	1.43
1200	21.44	27.63	10.02	11.38	1.17	0.71	43.81	27.93	1.46
1300	21.30	27.95	10.14	10.84	1.19	0.73	41.71	27.82	1.43
1400	21.17	28.20	10.36	10.36	1.21	0.74	44.66	27.76	1.49
1500	21.06	28.49	10.71	9.88	1.24	0.74	43.71	27.81	1.50
1600	20.94	28.78	11.18	9.48	1.26	0.75	41.74	27.56	1.49
1700	20.83	29.16	11.75	9.15	1.30	0.76	45.53	26.99	1.50
1800	20.70	29.46	12.32	8.85	1.33	0.77	44.51	27.65	1.51
1900	20.55	29.85	12.68	8.57	1.36	0.79	43.38	27.42	1.55
2000	20.36	30.28	12.55	8.34	1.40	0.81	43.23	27.32	1.60
2100	20.13	30.67	11.83	8.12	1.43	0.84	42.43	27.13	1.72
2200	19.85	31.25	10.61	7.90	1.48	0.88	43.11	27.07	1.83
2300	19.48	31.89	9.21	7.68	1.54	0.92	41.64	26.82	1.97
2400	19.05	32.54	7.83	7.45	1.59	0.97	41.69	26.24	2.17
2500	18.54	33.13	6.58	7.19	1.61	1.02	42.32	26.73	2.47

Note: Test data of Die packaged in industry standard 3x3 mm, 12-lead MCL package



## Typical Performance Data

### Definitions:

Input Return Loss = -S11 (dB)

Gain(Power Gain) = S21 (dB)

Reverse Isolation = -S12 (dB)

Output Return Loss = -S22 (dB)

TEST CONDITIONS: Vd = 8.00V, Id = 236mA @ Temperature = +25°C

FREQ	Gain	Isolation	Input Return Loss	Output Return Loss	Stability		IP-3 Output	1dB Comp. Output	Noise Figure
					K	Measure			
(MHz)	(dB)	(dB)	(dB)	(dB)			(dBm)	(dBm)	(dB)
20	23.65	26.47	10.44	14.98	1.02	0.46	37.83	26.16	1.52
30	23.29	26.02	11.37	14.91	1.02	0.45	39.91	26.25	1.73
40	23.06	25.93	11.78	14.24	1.03	0.45	40.11	27.45	1.35
50	22.89	25.32	11.99	13.75	1.02	0.38	39.72	27.75	1.37
60	22.82	25.64	12.17	13.61	1.03	0.43	41.71	27.43	1.36
70	22.76	25.68	12.28	13.43	1.03	0.43	47.00	27.26	1.35
80	22.71	25.61	12.32	13.36	1.03	0.43	46.38	27.52	1.38
90	22.68	25.60	12.36	13.31	1.03	0.43	41.24	27.87	1.42
100	22.66	25.63	12.40	13.25	1.04	0.43	39.34	27.57	1.42
150	22.59	25.59	12.46	13.18	1.04	0.43	42.26	27.69	1.38
200	22.55	25.61	12.45	13.16	1.04	0.44	43.06	27.80	1.40
250	22.52	25.66	12.40	13.20	1.04	0.45	40.83	27.90	1.36
300	22.49	25.69	12.37	13.22	1.05	0.46	41.47	28.06	1.38
350	22.46	25.77	12.26	13.25	1.05	0.47	38.36	28.08	1.38
400	22.43	25.78	12.16	13.30	1.05	0.48	40.73	28.09	1.42
450	22.39	25.91	12.03	13.32	1.06	0.50	41.80	27.94	1.39
500	22.35	25.92	11.82	13.37	1.06	0.50	42.10	27.86	1.40
550	22.30	26.07	11.67	13.35	1.07	0.53	44.94	28.18	1.40
600	22.25	26.20	11.45	13.33	1.07	0.55	41.73	28.04	1.47
650	22.19	26.28	11.23	13.26	1.08	0.56	42.95	28.15	1.47
700	22.14	26.37	11.05	13.17	1.08	0.57	40.51	28.06	1.45
750	22.06	26.45	10.85	13.04	1.09	0.59	44.14	27.98	1.42
800	21.99	26.62	10.69	12.92	1.10	0.61	42.21	27.96	1.42
850	21.92	26.74	10.55	12.79	1.10	0.63	41.75	28.15	1.42
900	21.86	26.88	10.39	12.62	1.11	0.64	43.41	28.12	1.42
950	21.79	26.99	10.23	12.45	1.12	0.65	42.74	28.16	1.44
1000	21.72	27.09	10.12	12.21	1.13	0.67	41.51	28.43	1.41
1100	21.57	27.41	9.95	11.73	1.15	0.69	42.36	28.22	1.47
1200	21.43	27.69	9.90	11.22	1.17	0.71	43.66	28.30	1.47
1300	21.28	27.98	10.01	10.73	1.19	0.73	41.50	28.20	1.51
1400	21.15	28.31	10.21	10.26	1.22	0.74	41.93	28.13	1.51
1500	21.03	28.63	10.55	9.79	1.25	0.75	42.47	28.10	1.51
1600	20.91	28.87	11.03	9.39	1.27	0.75	42.06	27.93	1.54
1700	20.80	29.23	11.64	9.03	1.31	0.76	42.90	27.39	1.54
1800	20.67	29.57	12.31	8.73	1.34	0.77	43.16	28.00	1.56
1900	20.53	29.89	12.83	8.45	1.37	0.78	44.21	27.78	1.62
2000	20.35	30.38	12.93	8.21	1.42	0.80	41.42	27.69	1.67
2100	20.13	30.85	12.33	7.97	1.47	0.83	40.45	27.51	1.76
2200	19.85	31.39	11.10	7.77	1.51	0.86	41.81	27.48	1.91
2300	19.48	32.02	9.61	7.55	1.57	0.91	43.52	27.23	2.06
2400	19.04	32.62	8.14	7.32	1.62	0.95	43.56	26.77	2.30
2500	18.51	33.30	6.82	7.07	1.67	1.00	45.11	27.22	2.56

Note: Test data of Die packaged in industry standard 3x3 mm, 12-lead MCL package



## Typical Performance Data

### Definitions:

Input Return Loss = -S11 (dB)

Gain(Power Gain) = S21 (dB)

Reverse Isolation = -S12 (dB)

Output Return Loss = -S22 (dB)

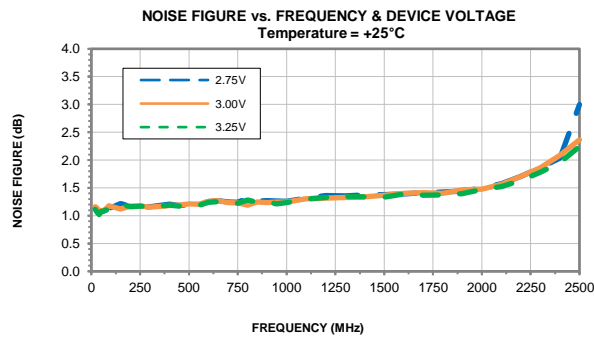
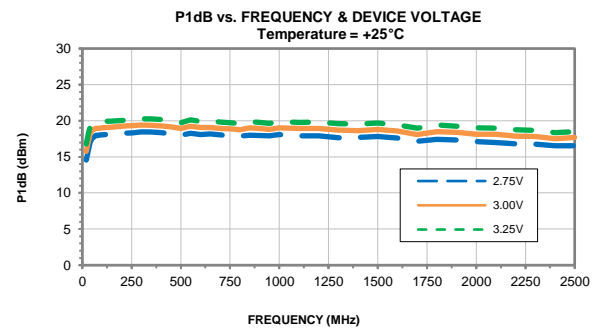
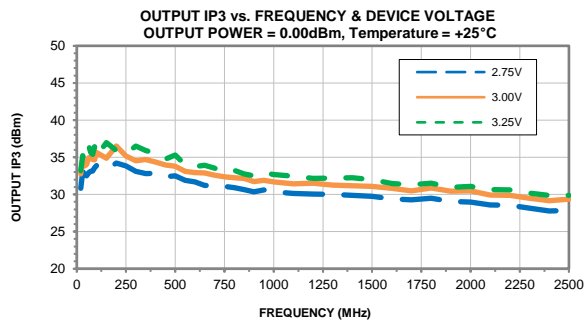
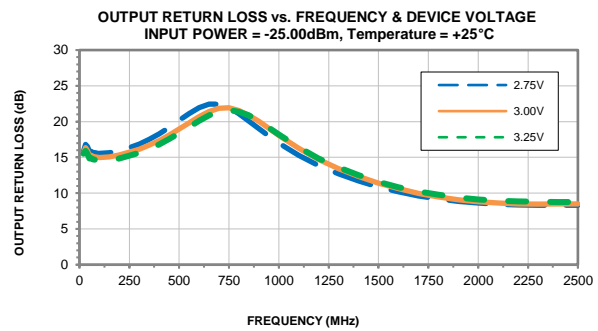
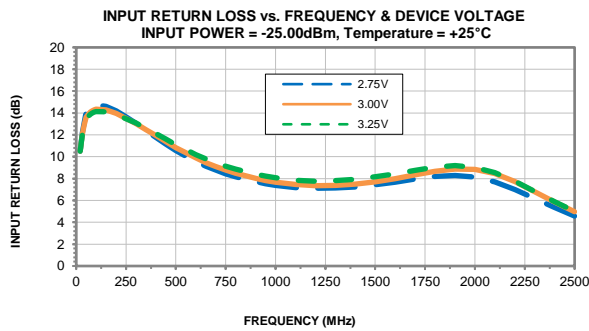
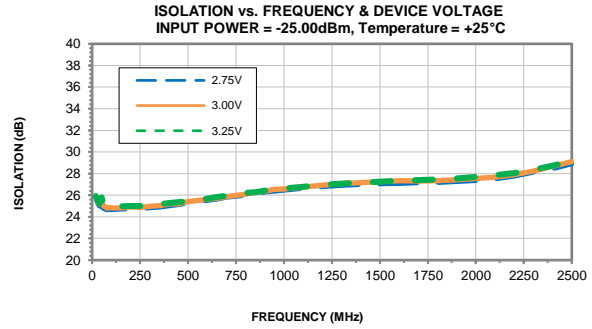
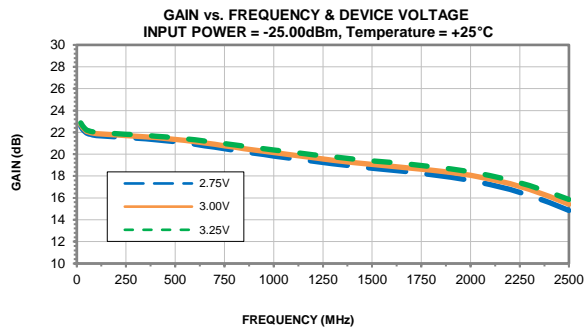
TEST CONDITIONS: Vd = 8.40V, Id = 245mA @ Temperature = +25°C

FREQ	Gain	Isolation	Input Return Loss	Output Return Loss	Stability		IP-3 Output	1dB Comp. Output	Noise Figure
					K	Measure			
(MHz)	(dB)	(dB)	(dB)	(dB)			(dBm)	(dBm)	(dB)
20	23.61	26.56	10.45	15.05	1.02	0.48	36.92	26.78	1.58
30	23.26	26.14	11.38	14.95	1.02	0.47	40.85	26.80	1.45
40	23.03	25.84	11.79	14.35	1.02	0.44	38.34	28.15	1.42
50	22.86	26.24	11.99	13.68	1.05	0.50	40.17	28.31	1.45
60	22.79	25.72	12.18	13.67	1.03	0.44	39.45	28.03	1.43
70	22.73	25.68	12.26	13.50	1.03	0.44	42.62	27.78	1.42
80	22.69	25.56	12.32	13.43	1.03	0.42	41.87	28.20	1.45
90	22.66	25.65	12.36	13.35	1.04	0.44	40.70	28.50	1.47
100	22.63	25.59	12.37	13.31	1.04	0.43	38.77	28.06	1.50
150	22.57	25.66	12.45	13.21	1.04	0.44	41.54	28.32	1.53
200	22.52	25.65	12.45	13.20	1.04	0.45	39.84	28.43	1.46
250	22.49	25.60	12.41	13.27	1.04	0.45	38.43	28.52	1.46
300	22.47	25.67	12.38	13.27	1.05	0.46	41.71	28.68	1.47
350	22.43	25.69	12.28	13.32	1.05	0.47	41.32	28.70	1.49
400	22.40	25.81	12.18	13.35	1.05	0.48	41.08	28.71	1.49
450	22.37	25.88	12.07	13.38	1.06	0.50	42.61	28.60	1.47
500	22.32	26.00	11.84	13.43	1.06	0.52	42.73	28.50	1.47
550	22.28	26.08	11.67	13.39	1.07	0.53	42.93	28.79	1.50
600	22.22	26.17	11.46	13.38	1.07	0.55	42.51	28.73	1.53
650	22.16	26.30	11.25	13.28	1.08	0.57	40.91	28.83	1.56
700	22.11	26.47	11.08	13.15	1.09	0.59	43.00	28.71	1.53
750	22.03	26.56	10.87	13.04	1.09	0.60	41.92	28.64	1.49
800	21.96	26.69	10.71	12.87	1.10	0.62	42.55	28.68	1.52
850	21.89	26.82	10.58	12.72	1.11	0.63	43.78	28.83	1.52
900	21.83	26.90	10.42	12.52	1.12	0.64	42.43	28.80	1.52
950	21.77	26.99	10.28	12.31	1.12	0.65	42.76	28.88	1.53
1000	21.70	27.19	10.17	12.07	1.13	0.67	41.46	29.05	1.50
1100	21.55	27.46	10.03	11.54	1.15	0.69	44.14	28.83	1.55
1200	21.41	27.70	10.01	11.03	1.17	0.71	41.99	28.91	1.57
1300	21.28	28.01	10.12	10.51	1.19	0.72	40.31	28.83	1.56
1400	21.15	28.32	10.35	10.05	1.22	0.73	41.65	28.74	1.62
1500	21.03	28.62	10.71	9.58	1.25	0.74	41.73	28.69	1.59
1600	20.92	28.94	11.17	9.21	1.28	0.75	41.42	28.54	1.64
1700	20.80	29.25	11.73	8.88	1.30	0.76	42.42	28.09	1.65
1800	20.67	29.56	12.29	8.58	1.33	0.76	43.53	28.60	1.63
1900	20.52	29.87	12.62	8.31	1.36	0.78	39.87	28.36	1.68
2000	20.33	30.45	12.46	8.08	1.42	0.81	42.01	28.27	1.73
2100	20.10	30.94	11.72	7.85	1.46	0.83	40.20	28.08	1.81
2200	19.81	31.50	10.51	7.62	1.51	0.87	42.19	28.07	1.93
2300	19.44	32.08	9.11	7.40	1.55	0.91	44.11	27.80	2.15
2400	19.00	32.70	7.74	7.16	1.59	0.96	43.76	27.36	2.34
2500	18.49	33.34	6.53	6.90	1.63	1.00	40.11	27.67	2.63

Note: Test data of Die packaged in industry standard 3x3 mm, 12-lead MCL package



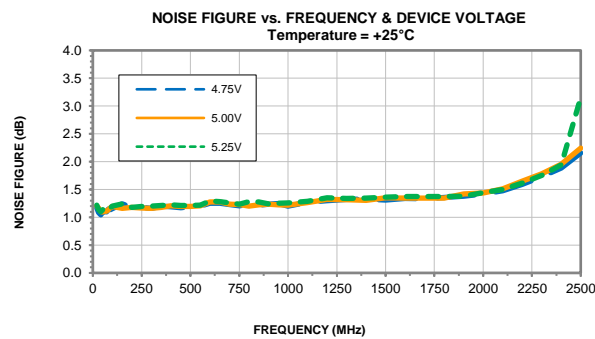
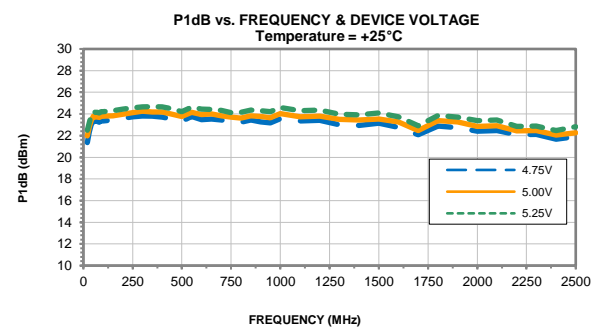
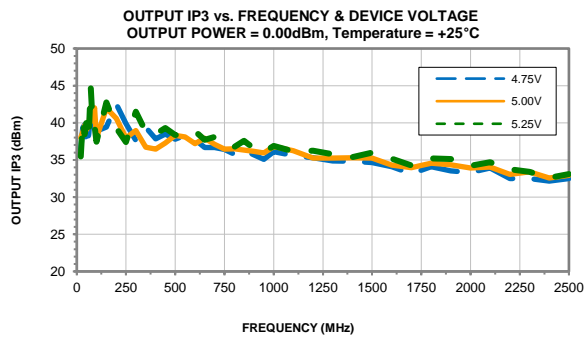
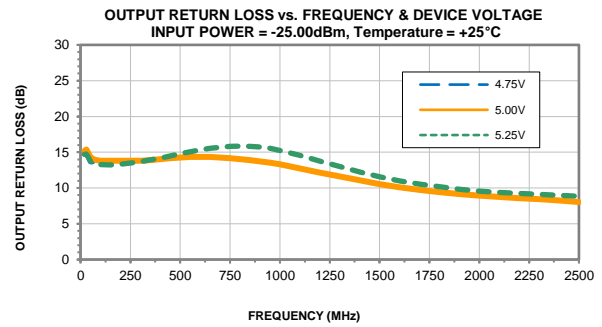
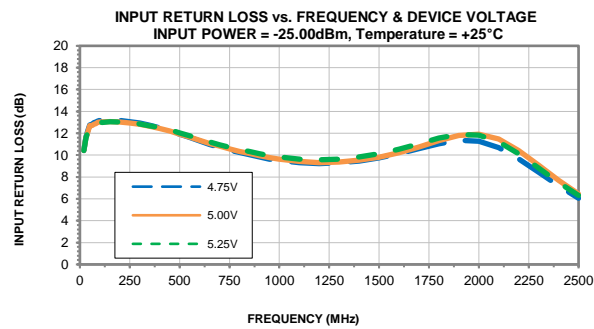
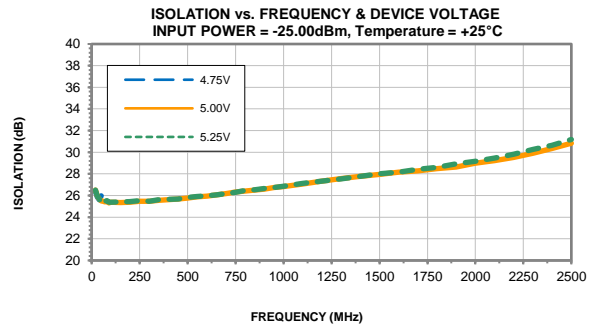
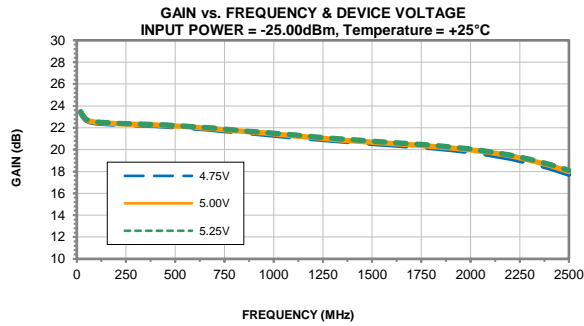
## Typical Performance Curves



Note: Test data of Die packaged in industry standard 3x3 mm, 12-lead MCL package

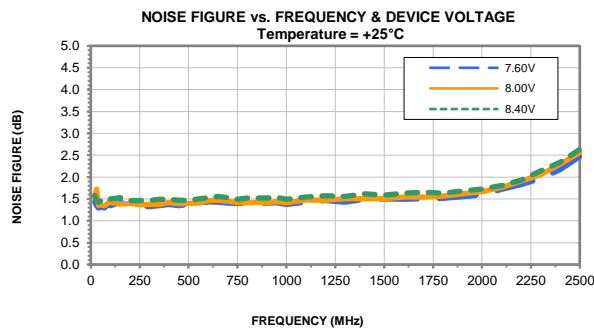
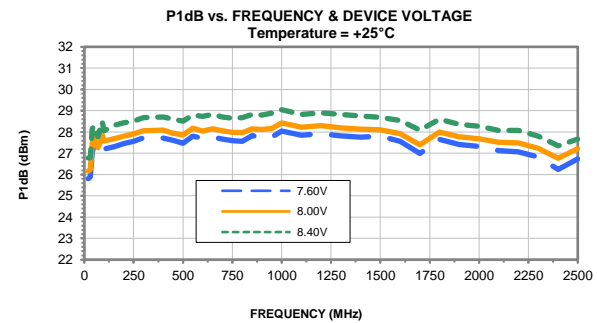
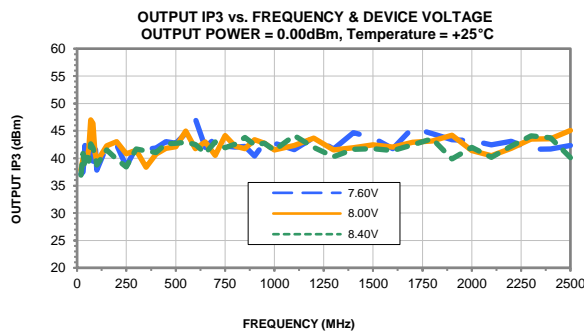
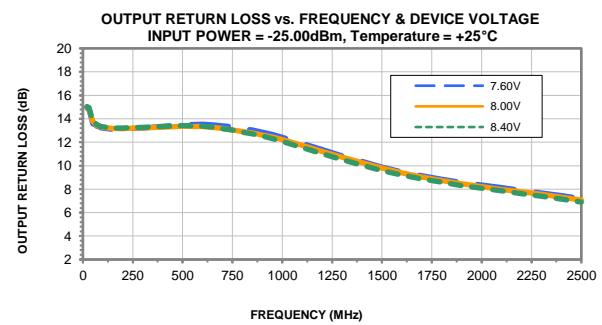
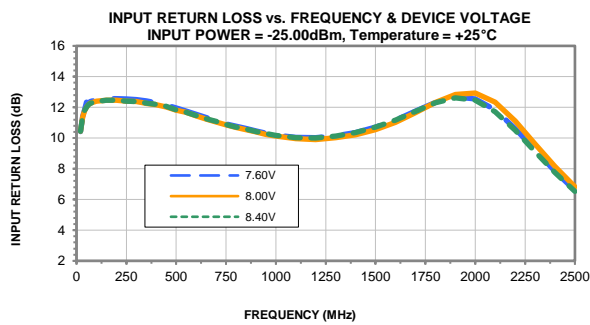
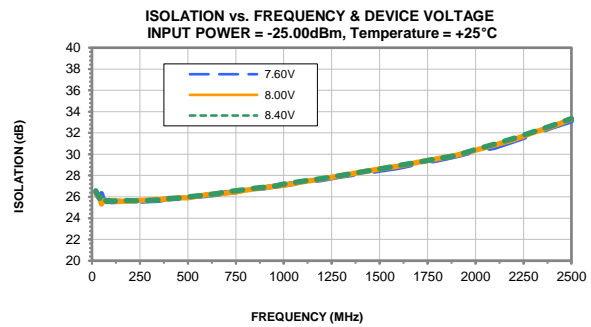
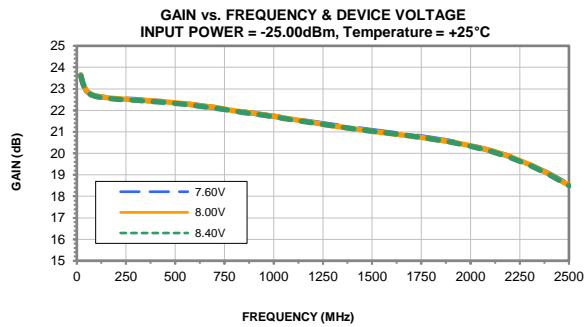


## Typical Performance Curves



Note: Test data of Die packaged in industry standard 3x3 mm, 12-lead MCL package

## Typical Performance Curves



Note: Test data of Die packaged in industry standard 3x3 mm, 12-lead MCL package

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85° C or -40° to 105° C or -55° to 105° C or -45° to 105° C Ambient Environment	Refer to Individual Model Data Sheet
Storage Environment (Die)	-65° to 150°C	Individual Model Data Sheet
Storage Environment(Packaging)	-40° to 70°C and 40 to 60% humidity (In Factory Shipped Package)	